



PRODUCT DATA SHEET



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Datasheet

es Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.



4-Line Ultra Low Capacitance TVS Diode Array

Features

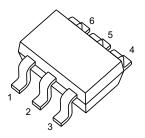
• Ultra low leakage: nA level

Operating voltage: 5V

- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test

Air discharge: ±25kV Contact discharge: ±20kV

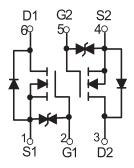
- IEC61000-4-4 (EFT) 40A (5/50ns)
- IEC61000-4-5 (Lightning) 5A (8/20µs)
- RoHS Compliant



SOT-363

Applications

- USB 2.0 power and data line
- Set-top box and digital TV
- Digital video interface (DVI)
- Notebook Computers
- SIM Ports
- 10/100/1000M Ethernet



Mechanical Characteristics

Package: SOT-363

Lead Finish: Lead Free

- UL Flammability Classification Rating 94V-0
- Quantity Per Reel:3,000pcs
- Reel Size:7inch

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	100	W	
ESD per IEC 61000-4-2 (Air)	Vesp	±25	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	±20	Γ\V	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$	
Storage Temperature Range	Тѕтл	-55 to +150	$^{\circ}$	



Electrical Characteristics(TA=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Reverse Working Voltage	V_{RWM}				5	V
Breakdown Voltage	V_{BR}	Iτ = 1mA	6			V
Reverse Leakage Current	I _R	VRWM = 5V			0.5	μA
Clamping Voltage	V _C	IPP = 1A (8 x 20 μs pulse)			15	V
Clamping Voltage	V _C	IPP = 5A (8 x 20 μs pulse)			20	V
Junction Capacitance	CJ	V _R = 0V, f = 1MHz		0.8		pF

Characteristic Curves

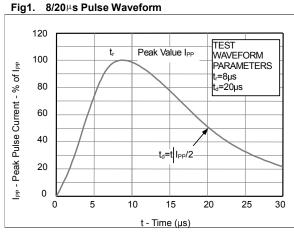


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

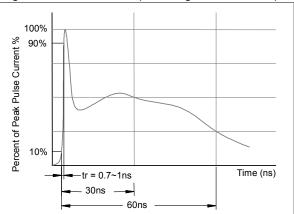
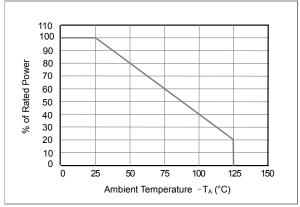
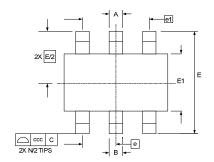


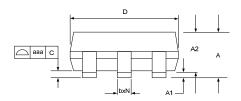
Fig3. Power Derating Curve





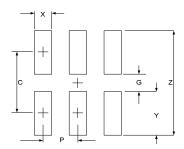
SOT-363 Package Outline Drawing





	DIMENSIONS					
	MILLIMETERS			INCHES		
SYM	MIN	NOM	MAX	MIN	NOM	MAX
Α			1.10			0.043
A1	0.00		0.10	0.000		0.004
A2	0.70	0.90	1.00	0.028	0.035	0.039
b	0.15		0.30	0.006		0.012
С	0.08		0.22	0.003		0.009
D	1.80	2.00	2.20	0.071	0.079	0.087
E1	1.15	1.25	1.35	0.045	0.049	0.053
Е	2.10 BSC			0.083 BSC		
е	0.65 BSC			0.026 BSC		
e1	1.30 BSC			0.051 BSC		
N	6			6		
aaa	0.10			0.004		
ccc	0.30			0.012		

Suggested Land Pattern



SYM	DIMENSIONS		
	MILLIMETERS	INCHES	
С	1.85	0.073	
G	1.00	0.039	
Р	0.65	0.026	
Х	0.40	0.016	
Υ	0.85	0.033	
Z	2.70	0.106	



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